

# MOS FIELD EFFECT TRANSISTOR 2SJ649

# SWITCHING P-CHANNEL POWER MOS FET

### **DESCRIPTION**

The 2SJ649 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
2SJ649	Isolated TO-220

### **FEATURES**

· Low on-state resistance:

 $R_{DS(on)1} = 48 \text{ m}\Omega \text{ MAX.} \text{ (VGS} = -10 \text{ V, ID} = -10 \text{ A)}$ 

 $R_{DS(on)2} = 75 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.0 \text{ V}, I_{D} = -10 \text{ A})$ 

Low input capacitance:

 $C_{iss} = 1900 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, \text{ Vgs} = 0 \text{ V})$ 

• Built-in gate protection diode

(Isolated TO-220)

### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Ves = 0 V)	Voss	-60	V	
Gate to Source Voltage (Vps = 0 V)	Vgss	∓20	V	
Drain Current (DC) (Tc = 25°C)	I <sub>D(DC)</sub>	I <sub>D(DC)</sub> ∓20		
Drain Current (pulse) Note1	D(pulse)	<b>∓70</b>	Α	
Total Power Dissipation (Tc = 25°C) PT 25 W				
Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	2.0	W	
Channel Temperature	Tch	150	°C	
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C	
Single Avalanche Current Note2	IAS	-20	Α	
Single Avalanche Energy Note2	Eas	40	mJ	



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = -20  $\rightarrow$  0 V

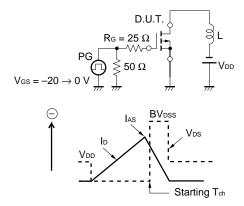


### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

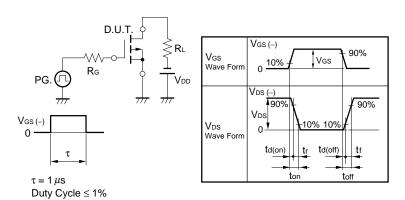
Characteristics	Symbol	Test Condtions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = −10 V, I <sub>D</sub> = −1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	yfs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -10 A	10	20		s
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = -10 V, ID = -10 A		38	48	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, I_{D} = -10 \text{ A}$		47	75	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1900		pF
Output Capacitance	Coss	Vgs = 0 V		350		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		140		pF
Turn-on Delay Time	td(on)	$V_{DD} = -30 \text{ V}, I_{D} = -10 \text{ A}$		10		ns
Rise Time	tr	V <sub>G</sub> S = −10 V		10		ns
Turn-off Delay Time	t <sub>d(off)</sub>	$R_G = 0 \Omega$		73		ns
Fall Time	t <sub>f</sub>			17		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -48 V		38		nC
Gate to Source Charge	Qgs	Vgs = -10 V		7		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = -20 A		10		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = 20 A, VGS = 0 V		0.95		٧
Reverse Recovery Time	trr	IF = 20 A, VGS = 0 V		49		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		100		nC

**Note** Pulsed: PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

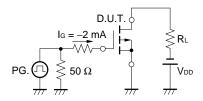
### TEST CIRCUIT 1 AVALANCHE CAPABILITY



### **TEST CIRCUIT 2 SWITCHING TIME**

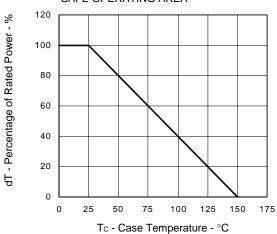


### **TEST CIRCUIT 3 GATE CHARGE**

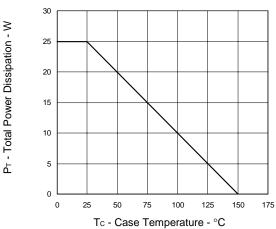


### TYPICAL CHARACTERISTICS (TA = 25°C)

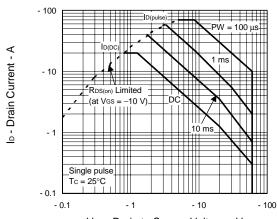
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

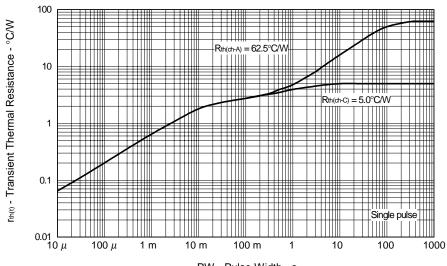


### FORWARD BIAS SAFE OPERATING AREA



 $V_{\text{\scriptsize DS}}$  - Drain to Source Voltage - V

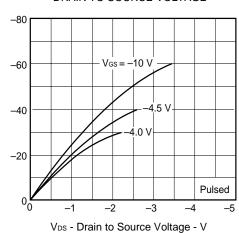
### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



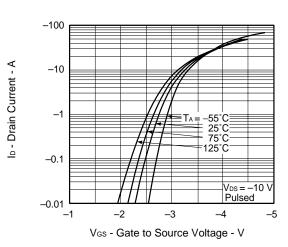
PW - Pulse Width - s

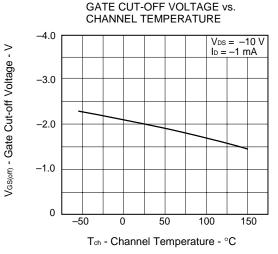
lo - Drain Current - A

## DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

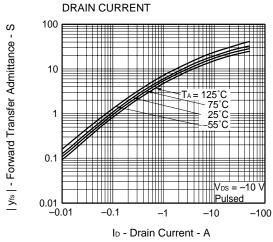


### FORWARD TRANSFER CHARACTERISTICS

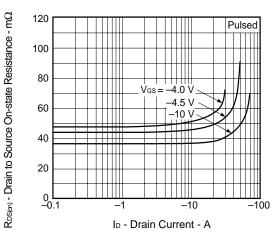




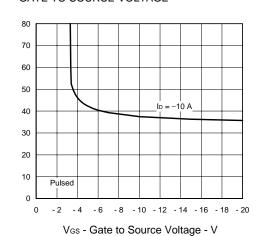
FORWARD TRANSFER ADMITTANCE vs.



# DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



# DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

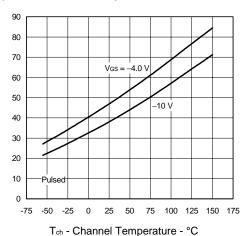


RDS(cn) - Drain to Source On-state Resistance - mΩ

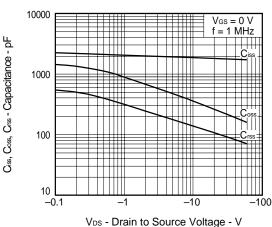
R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

IF - Diode Forward Current - A

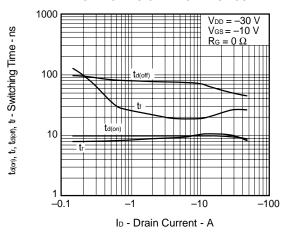
### DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



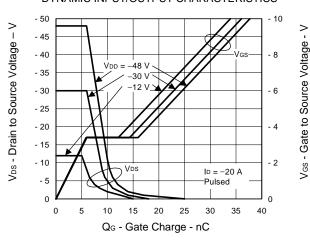
### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



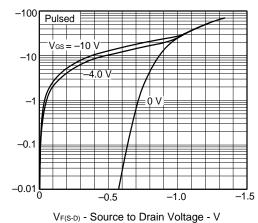
### SWITCHING CHARACTERISTICS



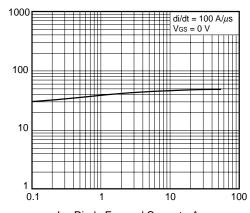
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



### SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

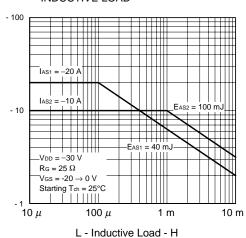


IF - Diode Forward Current - A

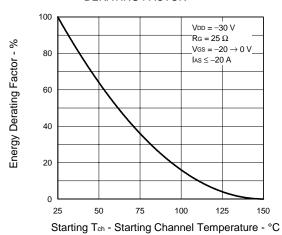
tr - Reverse Recovery Time - ns

IAS - Single Avalanche Current - A

# SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD

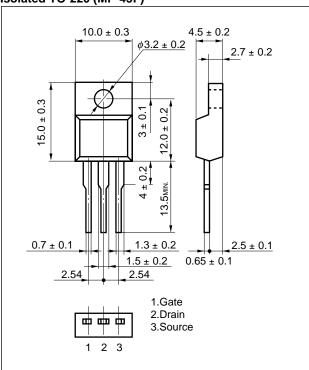


# SINGLE AVALANCHE ENERGY DERATING FACTOR

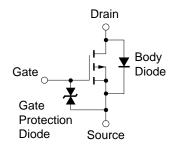


### PACKAGE DRAWING (Unit: mm)

### Isolated TO-220 (MP-45F)



### **EQUIVALENT CIRCUIT**



Remark

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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